

C2225X393JCGACTU

Aliases (C2225X393JCGAC7800) SMD Comm COG HV Flex, Ceramic, 0.039 uF, 5%, 500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 2225, 3.2 mm



Click here for the 3D model.

General Information	Information	
Series	SMD Comm COG HV Flex	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Ultra- Stable	
Features	FT-CAP, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	390 mg	
Shelf Life	78 Weeks	
MSL	1	

	Dimensions	
	Chip Size	2225
1	L	5.9mm +/-0.75mm
	W	6.4mm +/-0.4mm
	т	2.5mm +/-0.20mm
1	S	3.2mm MIN
I	В	0.7mm +/-0.35mm

Packaging SpecificationsPackagingT&R, 180mm, Plastic TapePackaging Quantity500

Specifications	
Capacitance	0.039 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	25.641 GOhms

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